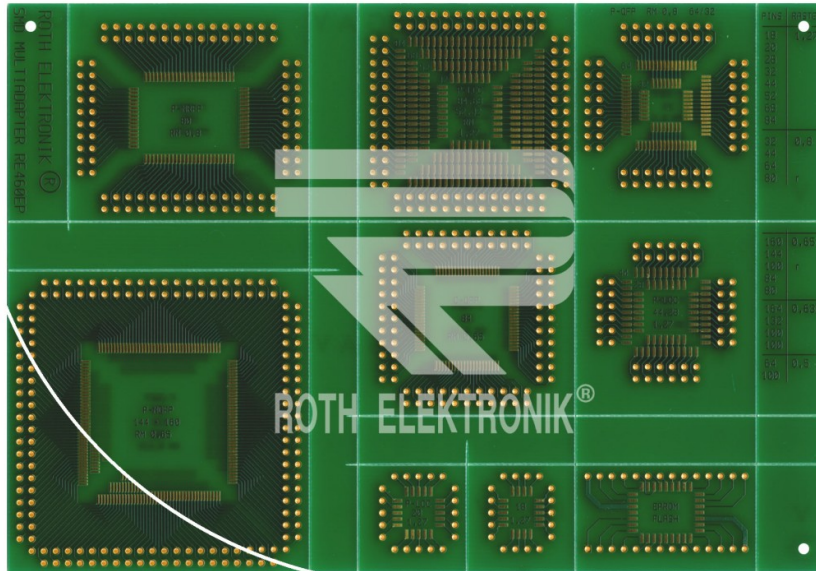


**Multiaadapter for SMT**



**RE460**

- EPOXY fibre-glass FR4 1.50 mm, double-side 35 µm CU (pth)
- chem. NI/AU and solder stop mask
- through holes plated bores dia 1.00 mm
- grid pitches from 0.50 mm to 1.27 mm
- adaption board for 23 different SMD-IC's
- 0.500 mm Pitch: 64, 100 Pin
- 0.635 mm Pitch: 164, 132, 100, 100 Pin
- 0.650 mm Pitch: 160, 144, 100, 84, 80 Pin
- 0.800 mm Pitch: 32, 44, 64, 80 Pin
- 1.270 mm Pitch: 18, 20, 28, 32, 44, 52, 68, 84 Pin
- prescratched rated break point for the separation of individual modules from the board
- manual soldering: as to the SMD individual processing in the laboratory area a freehanded coating of 100 to 200 single spots with precise metering hoppers is possible with grids from 0.50 mm to 1.27 mm
- reflow soldering by means of purpose made separate SMD templates
- size 120 x 175 mm

Modul-Nr	Pitch	Pin
RE460-01	0,800 mm	QFP 32,80
	0,500 mm	QFP 64
RE460-02	0,800 mm	QFP 80
	0,650 mm	QFP 100
RE460-03	0,650 mm	QFP 80, 84
RE460-04	0,650 mm	QFP 144, 160,
	0,635 mm	QFP 100, 132, 164
RE460-05	1,270 mm	PLCC 32, 52, 68, 84
	0,635 mm	QFP 100
	0,500 mm	QFP 100
RE460-06	1,270 mm	PLCC 28, 44
	0,800 mm	QFP 44
RE460-07	1,270 mm	PLCC 18
RE460-08	1,270 mm	PLCC 20
RE460-09	1,270 mm	PLCC-Eprom 32